



Procurement and Contracting Services

Request for Proposals for DNS/DHCP/IPAM Solution

ADDENDUM #1

**Please mark all proposal submission Envelopes with the
following information**

**Sealed RFP # L302302
Due on July 28th, 2023 no later than 1:00 PM, MST**

The timeline for RFP L302301 has been amended as follows:

Section 3.3:

Original Schedule

05/26/2023 Issuance of RFP

06/16/2023 Technical Questions/Inquiries due June 16th, 2023 no later than 1:00 PM, MST

07/03/2023 RFP is Due July 3rd, 2023, no later than 1:00 PM, MST

TBD Vendor Presentations, (if necessary)

Revised to:

05/26/2023 Issuance of RFP

07/14/2023 Technical Questions/Inquiries due July 14th, 2023 no later than 1:00 PM, MST

07/28/2023 RFP is Due July 28th, 2023, no later than 1:00 PM, MST

TBD Vendor Presentations, (if necessary)

Section 3.5: PROPOSAL PREPARATION INSTRUCTIONS

Change: Technical question deadline extended to July 14th

RFP submission deadline extended to July 28th

Section 3.6 PROPOSAL SUBMISSION AND SUBSEQUENT ACTION

Change: Technical question deadline extended to July 14th

RFP submission deadline extended to July 28th

Section 3.8: Proposal Submission and Subsequent Action

Change: Technical question deadline extended to July 14th

RFP submission deadline extended to July 28th

******If you have already submitted a response: you do not need to do anything unless you would like to update or change your response. Please upload your updated response to the Box folder as mentioned in section 3.6 of the original Request for Proposal document.****

End of addendum, all else remains the same.